TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type

# SSM3J118TU

#### High-Speed Switching Applications

- 4 V drive
- Low ON-resistance:  $R_{on} = 480 \text{ m}\Omega \text{ (max)} (@V_{GS} = -4 \text{ V})$  $R_{on} = 240 \text{ m}\Omega \text{ (max)} (@V_{GS} = -10 \text{ V})$

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage		V <sub>GSS</sub>	$\pm20$	V	
Drain current	DC	I <sub>D</sub>	-1.4	A	
	Pulse	I <sub>DP</sub>	-2.8		
Drain power dissipation		PD (Note 1)	800	mW	
		PD (Note 2)	500		
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

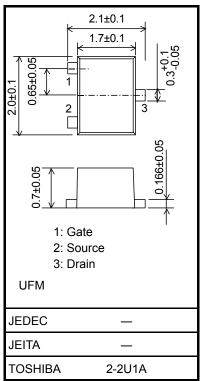
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a ceramic board. (25.4 mm  $\times$  25.4 mm  $\times$  0.8 t, Cu Pad: 645 mm<sup>2</sup>) Note 2: Mounted on an FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 

#### Electrical Characteristics (Ta = 25°C)



Weight: 6.6 mg (typ.)

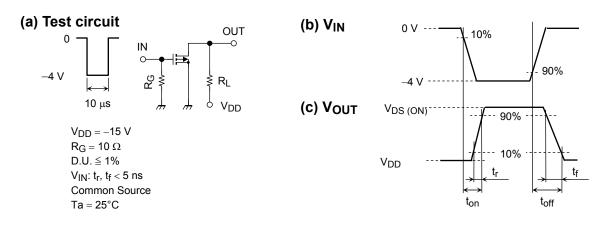
Charact	teristic	Symbol	Test Condition	Min	Тур.	Мах	Unit
Drain-source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-30		_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +20 \text{ V}$	-15		_	
Drain cutoff current	t	I <sub>DSS</sub>	$V_{DS}=-30~V,~V_{GS}=0$	_	_	-1	μA
Gate leakage curre	ent	I <sub>GSS</sub>	$V_{GS}=\pm 16~V,~V_{DS}=0$	_		±1	μA
Gate threshold volt	age	V <sub>th</sub>	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-1.2		-2.6	V
Forward transfer a	dmittance	Y <sub>fs</sub>	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -0.65 \text{ A}$ (Note 3)	0.8	1.5	_	S
Drain-source ON-resistance		R <sub>DS (ON)</sub>	$I_D = -0.65 \text{ A}, V_{GS} = -10 \text{ V}$ (Note 3)		180	240	mΩ
			$I_D = -0.4 \text{ A}, V_{GS} = -4 \text{ V}$ (Note 3)	_	360	480	
Input capacitance		C <sub>iss</sub>	$V_{DS}=-15~V,~V_{GS}=0,~f=1~MHz$	_	137	_	pF
Output capacitance		C <sub>oss</sub>	$V_{DS} = -15 \text{ V},  V_{GS} = 0,  f = 1  \text{MHz}$		39	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		20		pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -15 \text{ V}, \text{ I}_{D} = -0.65 \text{ A},$		15		ns
	Turn-off time	t <sub>off</sub>	$V_{GS}$ = 0 to –4 V, $R_{G}$ = 10 $\Omega$		14		
Drain-source forward voltage		V <sub>DSF</sub>	$I_D = 1.4 \text{ A}, V_{GS} = 0 \text{ V}$ (Note 3)	_	0.85	1.2	V

Unit: mm

Note 3: Pulse test

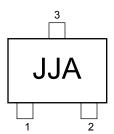
# <u>TOSHIBA</u>

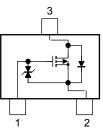
### Switching Time Test Circuit



#### Marking

#### Equivalent Circuit (top view)





#### Precaution

 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D = -1$  mA for this product. For normal switching operation,  $V_{GS}$  (on) requires a higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires a lower voltage than  $V_{th}$ .

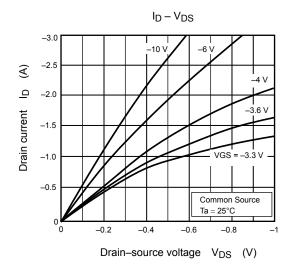
(The relationship can be established as follows: V<sub>GS (off)</sub> < V<sub>th</sub> < V<sub>GS (on)</sub>.)

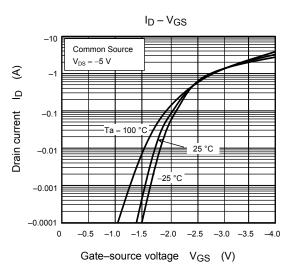
Take this into consideration when using the device.

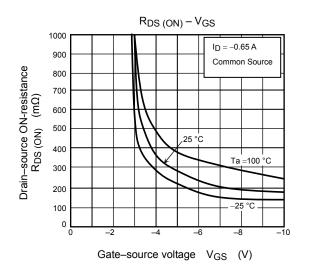
#### **Handling Precaution**

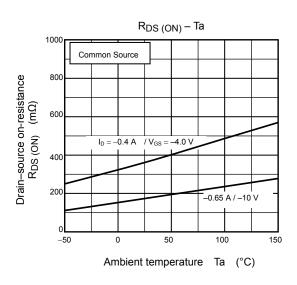
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

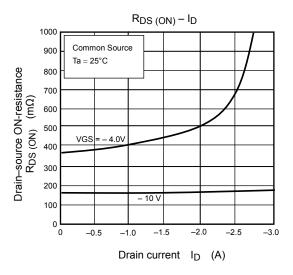
# **TOSHIBA**

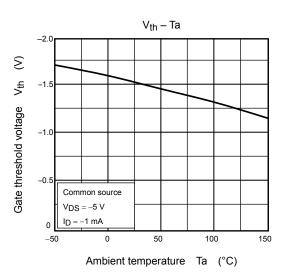




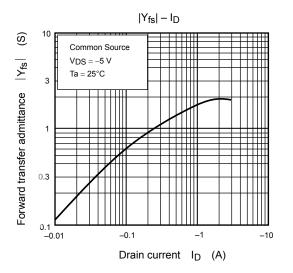


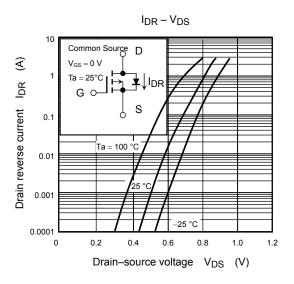


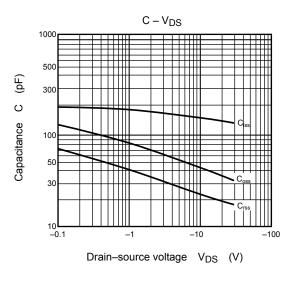


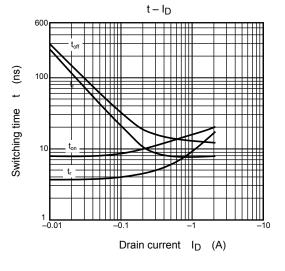


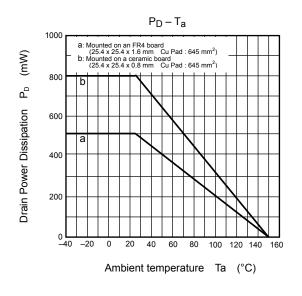
## TOSHIBA











 $\mathsf{t}-\mathsf{I}_\mathsf{D}$ 600 Transient thermal impedance Rth (°C/W) 10 a: Mount mic boa Cu Pad : 645 mm<sup>2</sup>) Cu Pad : 645 mm<sup>2</sup>) C Mounted on an FR4 board (25.4 x 25.4 x 1.6 mm Cu Pad : 0.36 mm<sup>2</sup> x 3) 0.01 0.1 10 0.001 100 600 1 Pulse Width tw (s)

#### **RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

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